

ES2A/A - ES2D/A

2.0A SURFACE MOUNT SUPER-FAST RECTIFIER

Features

Glass Passivated Die Construction Super-Fast Recovery Time For High Efficiency Surge Overload Rating to 50A Peak

Ideally Suited for Automated Assembly

Lead Free Finish/RoHS Complaint (Note 4)

Mechanical Data

Case: SMA/SMB

Case Material: Molded Plastic. UL Flammability

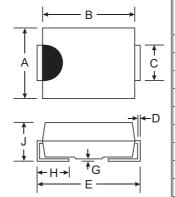
Classification Rating 94V-0

Moisture Sensitivity: Level 1 per J-STD-020C

Terminals: Lead Free Plating (Matte Tin

Finish). Solderable per MIL-STD-202, Method 208 (3)

Polarity: Cathode Band or Cathode Notch Marking Information: See Page 3 Ordering Information: See Page 3 SMA Weight: 0.064 grams (approximate) SMB Weight: 0.093 grams (approximate)



Dim	SI	IΑ	SMB			
	Min	Max	Min	Max		
Α	2.29	2.92	3.30	3.94		
В	4.00	4.60	4.06	4.57		
С	1.27	1.63	1.96	2.21		
D	0.15	0.31	0.15	0.31		
E	4.80	5.59	5.00	5.59		
G	0.10	0.20	0.10	0.20		
Н	0.76	1.52	0.76	1.52		
J	2.01	2.30	2.00	2.40		
All Dimensions in mm						

AA, BA, CA, DA Suffix Designates SMA Package A, B, C, D, Suffix Designates SMB Package

Maximum Ratings and Electrical Characteristics @ TA = 25 C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Characteristic	Symbol	ES2A/A	ES2B/A	ES2C/A	ES2D/A	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage (Note 5)	V _{RRM} V _{RWM} V _R	50	100	150	200	V
RMS Reverse Voltage	V _{R(RMS)}	35	70	105	140	V
Average Rectified Output Current @ T _T = 110 C	Io	2.0			Α	
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load		50				А
Forward Voltage @ I _F = 2.0A	V _{FM}	0.92			V	
Peak Reverse Current @ T _A = 25 C at Rated DC Blocking Voltage (Note 5) @ T _A = 125 C		5.0 350				Α
Reverse Recovery Time (Note 3)		25				ns
Typical Total Capacitance (Note 2)	Ст		2	:5		pF
Typical Thermal Resistance, Junction to Terminal (Note 1)	R _{JT}	20				°C/W
Operating and Storage Temperature Range		-55 to +150				С

Notes:

- 1. Unit mounted on PC board with 5.0 mm² (0.013 mm thick) copper pads as heat sink.
- 2. Measured at 1.0MHz and applied reverse voltage of 4.0V DC.
- 3. Measured with I_F = 0.5A, I_R = 1.0A, I_{rr} = 0.25A. See Figure 5.
- 4. RoHS revision 13.2.2003. Glass and high temperature solder exemptions applied, see *EU Directive Annex Notes 5 and 7*.
- $5. \ \ \ \, \text{Short duration pulse test used to minimize self-heating effect.}$

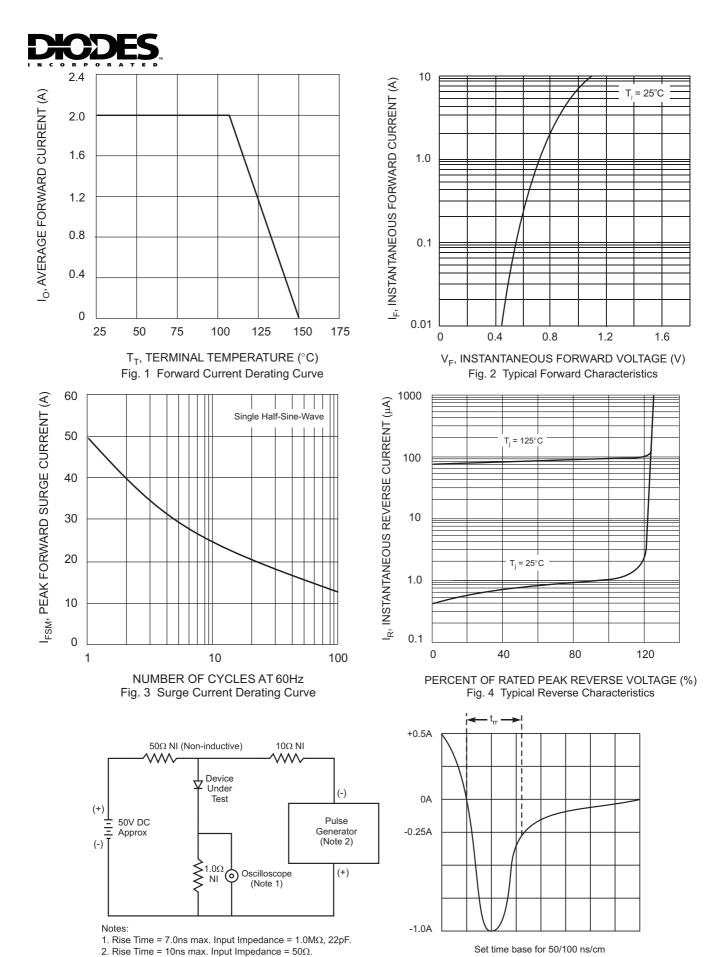


Fig. 5 Reverse Recovery Time Characteristic and Test Circuit



Ordering Information (Note 6)

Device	Packaging	Shipping
ES2xA-13-F	SMA	5000/Tape & Reel
ES2x-13-F	SMB	3000/Tape & Reel

^{*} x = Device type, e.g. ES2BA-13-F (SMA package); ES2A-13-F (SMB package).

Notes: 6. For Packaging Details, go to our website at http://www.diodes.com/datasheets/ap02007.pdf.

Marking Information



ES2XA = Product type marking code, ex: ES2BA (SMA package)
ES2X = Product type marking code, ex: ES2A (SMB package)
] | = Manufacturers' code marking
YWW = Date code marking
Y = Last digit of year ex: 2 for 2002
WW = Week code 01 to 52

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